

Notice of References Cited	Application/Control No. 09/467,253	Applicant(s)/Patent Under Reexamination CHITTIPEDDI ET AL.	
	Examiner Michelle Estrada	Art Unit 2823	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	B	US-6,319,728	11-2001	Bhan et al.	438/680
	C	US-5,045,151	09-1991	Edell, David J.	252/79.3
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	E	US-5,565,378	10-1996	Harada et al.	228/180.5
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Harper, Charles A., "Electronic Packaging and Interconnection Handbook", 1991 by McGraw-Hill, page 10.47.
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
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